

Features

- Typical Isolation: 35 dB (2.0 GHz)
- Typical Insertion Loss: 1.2 dB (2.0 GHz)
- Integral ASIC/CMOS Driver
- 50 Ohm Nominal Impedance
- Low DC Power Consumption
- Test Boards Available
- Lead-Free QSOP-24 Package
- 100% Matte Tin Plating over Copper
- Halogen-Free "Green" Mold Compound
- 260°C Reflow Compatible
- RoHS* Compliant Version of SW65-0440

Description

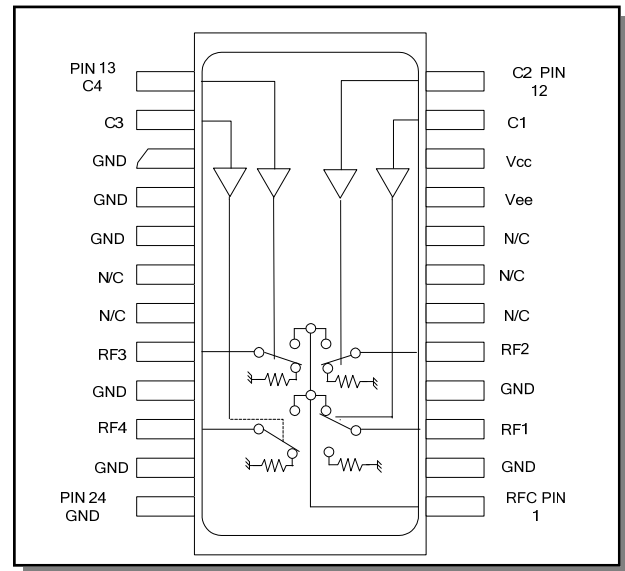
M/A-COM's MASWCC0009 is a GaAs MMIC absorptive SP4T switch with an integral silicon ASIC driver. This device is in a 24-lead plastic package. This switch offers excellent broadband performance and repeatability from DC to 3 GHz, while maintaining low DC power dissipation. The MASWCC0009 is ideally suited for wireless infrastructure applications.

Ordering Information

Part Number	Package
MASWCC0009	Bulk Packaging
MASWCC0009TR	1000 piece reel
MASWCC0009-TB	Sample Test Board

Note: Reference Application Note M513 for reel size information.

Functional Schematic



Pin Configuration

Pin No.	Function	Pin No.	Function
1	RFC	13	C4
2	GND	14	C3
3	RF1	15	GND
4	GND	16	GND
5	RF2	17	GND
6	NC	18	NC
7	NC	19	NC
8	NC	20	RF3
9	V _{EE}	21	GND
10	V _{CC}	22	RF4
11	C1	23	GND
12	C2	24	GND

NC = No Connection

* Restrictions on Hazardous Substances, European Union Directive 2002/95/EC.

GaAs SP4T Switch, Absorptive DC - 3.0 GHz

Rev. V7

Electrical Specifications: $T_A = 25^\circ\text{C}$

Parameter	Test Conditions	Units	Min	Typ	Max
Insertion Loss	DC - 2.0 GHz	dB	—	1.2	1.8
	DC - 3.0 GHz	dB	—	1.3	2.5
Isolation	DC - 2.0 GHz	dB	32	35	—
	DC - 3.0 GHz	dB	25	29	—
VSWR RF1-RF4 On RF1- RF4 Off RFC RFC	DC - 3.0 GHz	Ratio	—	1.2:1	1.6:1
	DC - 3.0 GHz	Ratio	—	1.4:1	1.8:1
	DC - 2.0 GHz	Ratio	—	1.2:1	1.5:1
	DC - 3.0 GHz	Ratio	—	1.6:1	2.2:1
Switching Speed ¹ T_{rise} T_{fall} T_{on} T_{off} Transients	10%/90%, 90%/10%	ns	—	15	50
	50% TTL to 90%/10% RF	ns	—	50	150
	In-band (peak to peak)	mV	—	50	150
1 dB Compression	.05 GHz	dBm	—	+20	—
	.5 - 3.0 GHz	dBm	—	+27	—
Input IP_3	Two tone inputs 0.05 GHz	dBm	—	+35	—
	up to +5 dBm 0.5 - 3.0 GHz	dBm	—	+46	—
V_{CC}	—	V	+4.5	+5.0	+5.5
V_{EE}	—	V	-8.0	-5.0	-4.75
V_{IL} V_{IH}	LOW-level input voltage	V	0.0	—	0.8
	HIGH-level input voltage	V	2.0	—	5.0
I_{in} (Input Leakage Current)	$V_{in} = V_{CC}$ or GND	μA	-1.0	—	1.0
I_{cc} (Quiescent Supply Current)	$V_{cntrl} = V_{CC}$ or GND	μA	—	250	400
ΔI_{cc} (Additional Supply Current Per TTL Input Pin)	$V_{CC} = \text{Max}$, $V_{cntrl} = V_{CC} - 2.1 \text{ V}$	mA	—	—	1.0
I_{EE}	V_{EE} min to max, $V_{in} = V_{IL}$ or V_{IH}	mA	-1.0	-0.2	—

Absolute Maximum Ratings ^{2,3,4}

1. Decoupling capacitors (0.1 μF) are required on the power supply lines.

Parameter	Absolute Maximum
Max. Input Power 0.05 GHz 0.5 - 3.0 GHz	+27 dBm +34 dBm
V_{CC}	$-0.5\text{V} \leq V_{CC} \leq +7.0\text{V}$
V_{EE}	$-8.5\text{V} \leq V_{EE} \leq +0.5\text{V}$
$V_{CC} - V_{EE}$	$-0.5\text{V} \leq V_{CC} - V_{EE} \leq 14.5\text{V}$
V_{in}^5	$-0.5\text{V} \leq V_{in} \leq V_{CC} + 0.5\text{V}$
Operating Temperature	-40°C to $+85^\circ\text{C}$
Storage Temperature	-65°C to $+125^\circ\text{C}$

- Exceeding any one or combination of these limits may cause permanent damage to this device.
- M/A-COM does not recommend sustained operation near these survivability limits.
- When the RF input is applied to the terminated port, the absolute maximum power is +30 dBm.
- Standard CMOS TTL interface, latch-up will occur if logic signal is applied prior to power supply.

Truth Table (Switch)

TTL				RF Common To:			
C1	C2	C3	C4	RF1	RF2	RF3	RF4
1	0	0	0	On	Off	Off	Off
0	1	0	0	Off	On	Off	Off
0	0	1	0	Off	Off	On	Off
0	0	0	1	Off	Off	Off	On

0 = TTL Low; 1 = TTL High

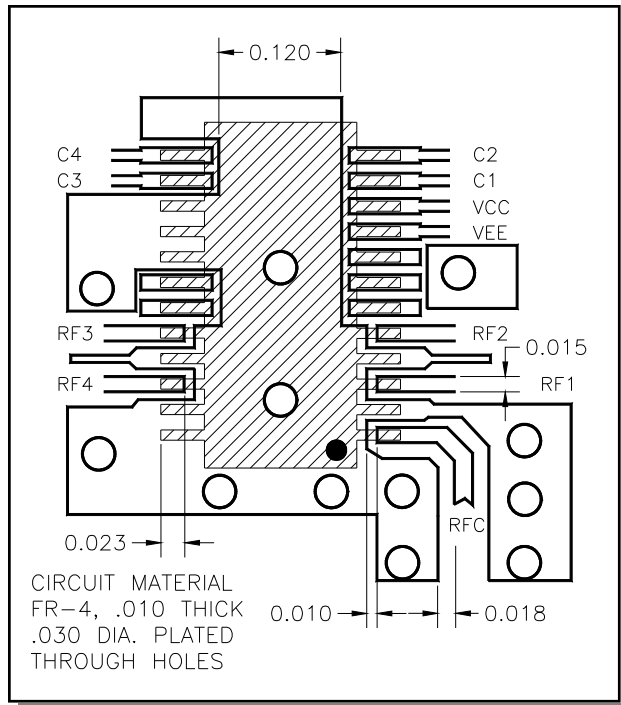
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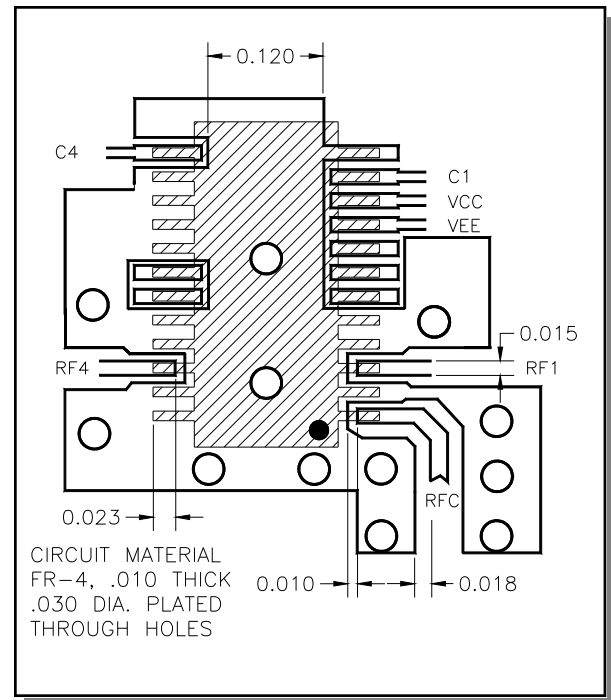
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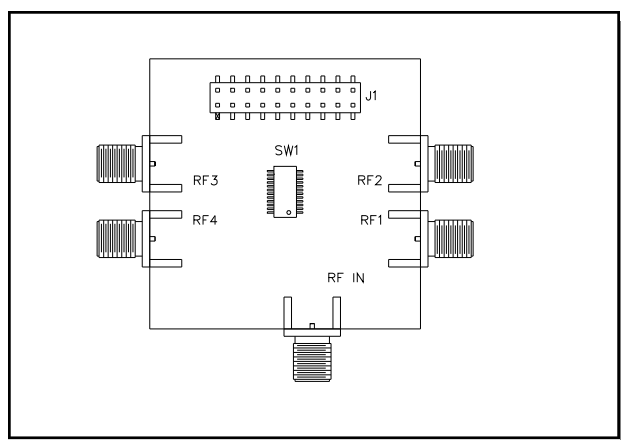
Recommended PCB Layout—SP4T



Recommended PCB Layout—SP2T



Evaluation Board - SW65-0440-TB



Handling Procedures

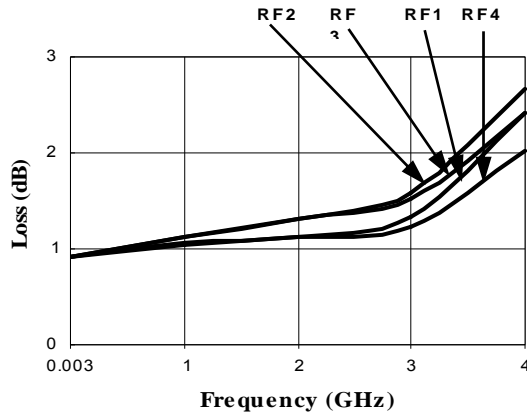
Please observe the following precautions to avoid damage:

Static Sensitivity

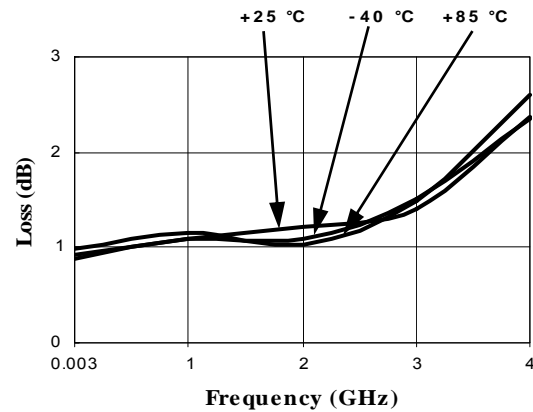
Gallium Arsenide Integrated Circuits are sensitive to electrostatic discharge (ESD) and can be damaged by static electricity. Proper ESD control techniques should be used when handling these devices.

Typical Performance Curves

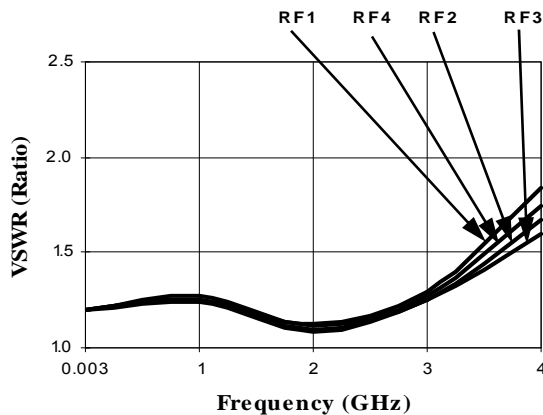
Insertion Loss (dB) @ +25°C



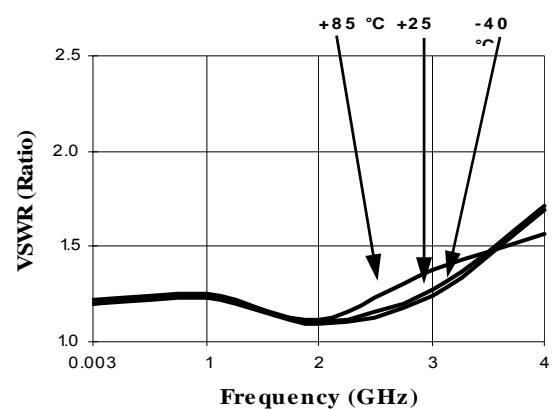
Loss Variation Over Temp. (dB)



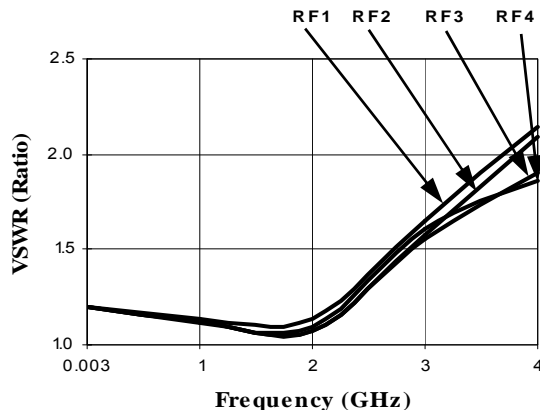
RF1 - RF4 On VSWR @ +25°C



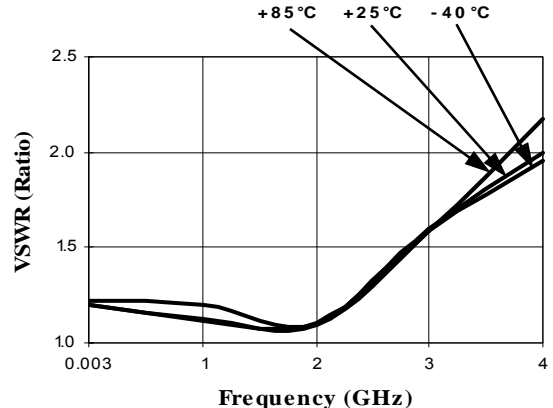
RF1 - RF4 On VSWR Temp. Variation



RFC On VSWR @ +25°C

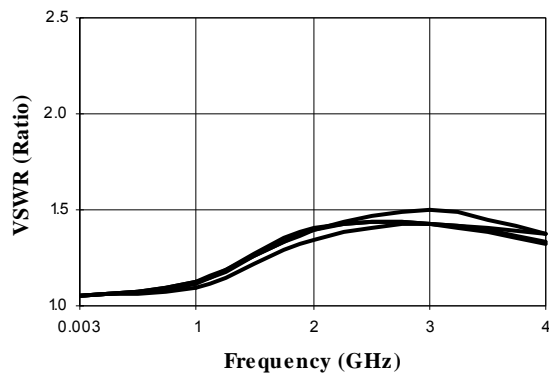


RFC On VSWR Temp. Variation

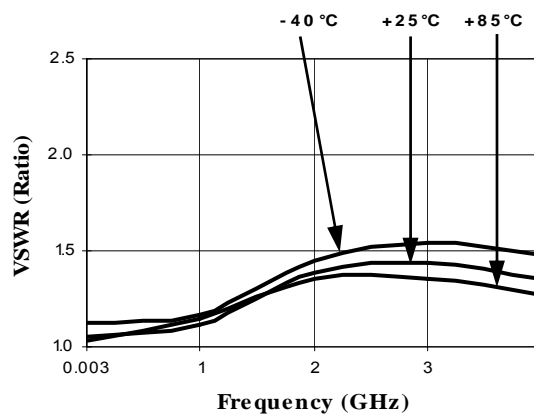


Typical Performance Curves

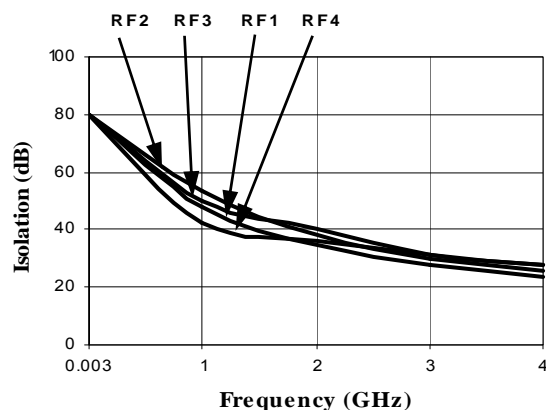
RF1 - RF4 Off VSWR @ +25°C



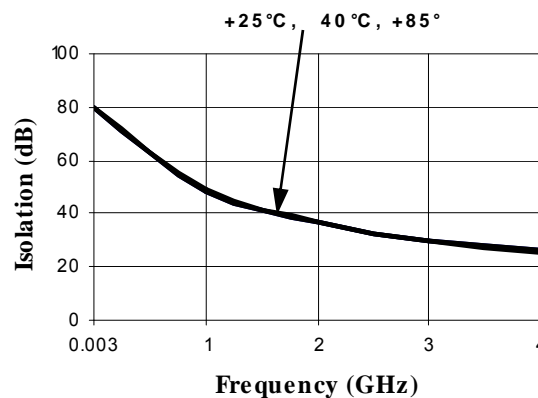
RF1 - RF4 Off VSWR Temp. Variation



Isolation (dB) @ +25°C



Isolation Temp. Variation (dB)



Rev. V7

The drawing illustrates the mechanical specifications of a 24-pin DIP package. It includes three main views: a top view, a side view, and a cross-section view (SECTION B-B).

Top View Dimensions:

- Overall width: $.3406$ (8.65 mm)
- Pin pitch: $.0250$ (6.4 mm)
- Pin 1 location: $.0650$ (1.65 mm) from the left edge, $.0492$ (1.25 mm) from the top edge.
- Pin 24 location: $.0690$ (1.75 mm) from the left edge, $.0530$ (1.35 mm) from the top edge.
- Pin 12 location: $.1535$ (3.90 mm) from the left edge, $.2362$ (6.00 mm) from the top edge.
- Pin 23 location: $.0100$ (0.25 mm) from the right edge, $.0040$ (0.10 mm) from the bottom edge.
- Pin 24 location: $.0120$ (0.30 mm) from the right edge, $.0080$ (0.20 mm) from the bottom edge.

Side View Dimensions:

- Package height: $.0410$ (1.04 mm)
- Lead height: $.0500$ (1.27 mm)
- Lead thickness: $.0160$ (0.41 mm)

Cross-section View (SECTION B-B) Dimensions:

- Lead thickness: $.0120$ (0.30 mm)
- Lead width: $.0080$ (0.20 mm)
- Lead height: $.0080$ (0.20 mm)
- Lead width (with plating): $.0100$ (0.25 mm)
- Lead height (with plating): $.0010$ (0.03 mm)
- Lead width (with plating): $.0020$ (0.05 mm)
- Lead height (with plating): $.0010$ (0.03 mm)
- Lead width (with plating): $.0020$ (0.05 mm)

NOTES:

- REFERENCE JEDEC MO-137-AE, FOR ADDITIONAL DIMENSIONAL AND TOLERANCE INFORMATION.
- REFERENCE M538 APPLICATION NOTE FOR FOOTPRINT INFORMATION.
- ALL DIMENSIONS SHOWN AS INCHES/MM.

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- Подбор аналогов;
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- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



Как с нами связаться

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